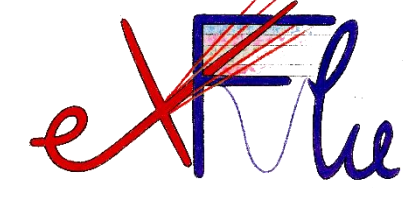


Advances in the TCAD modelling of non-irradiated and irradiated Low-Gain Avalanche Diode sensors

T. Croci<sup>(1,*), A. Morozzi<sup>(1), P. Asenov<sup>(2,1), A. Fondacci^{(3,1), F. Moscatelli^{(2,1),}}
L. Lanteri^{(5), F. Siviero^{(5), V. Sola^{(5,4), M. Ferrero^{(4), D. Passeri^(3,1)}}}}</sup></sup></sup>

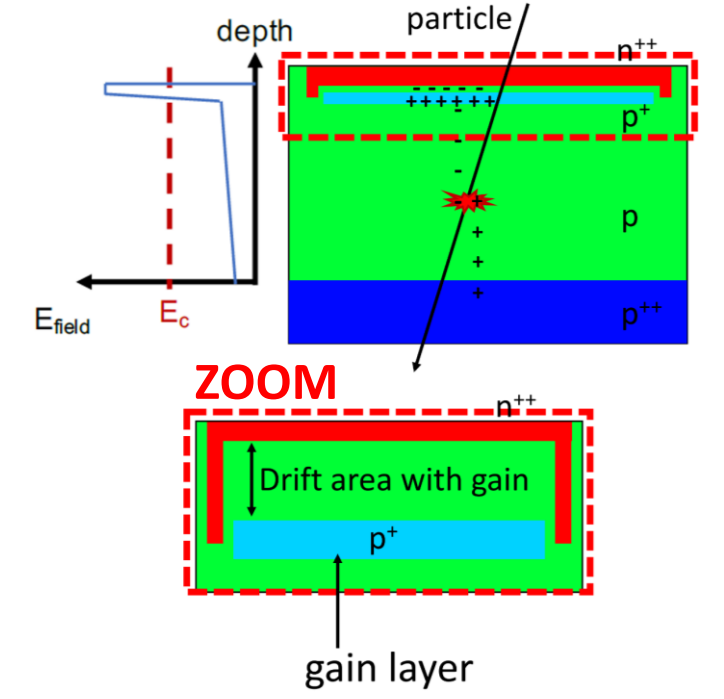


- 1) Istituto Nazionale di Fisica Nucleare (INFN), Perugia, Italy.
- 2) Istituto Officina dei Materiali (IOM) CNR, Perugia, Italy.
- 3) Dipartimento di Ingegneria, Università di Perugia, Perugia, Italy.
- 4) Istituto Nazionale di Fisica Nucleare (INFN), Torino, Italy.
- 5) Dipartimento di Fisica, Università di Torino, Torino, Italy.



Motivations

- ✓ Developing radiation-resistant silicon detectors for particle tracking in the next generation of high-energy physics experiments (e.g., HL-LHC or FCC) able to efficiently operate in extreme radiation environments, $\Phi \sim 1 \times 10^{17} \text{ n}_{\text{eq}}/\text{cm}^2$ [1].
 - ✓ The Low-Gain Avalanche Diode (LGAD) technology (see figure on the right) helps to mitigate the radiation damage effects by exploiting the controlled charge multiplication mechanism [2].
 - ✓ To evaluate the impact of several design strategies and the radiation damage effects on the LGAD sensors electrical behavior:
 - ad-hoc advanced Technology CAD (TCAD) modelling before and after irradiation;
 - massive test campaign on specifically devised structures, both non-irradiated and irradiated ones.
- Validation of the development framework (in this work, based on the Hamamatsu technology - HPK)
→ Sensor design and optimization before the large volume production.

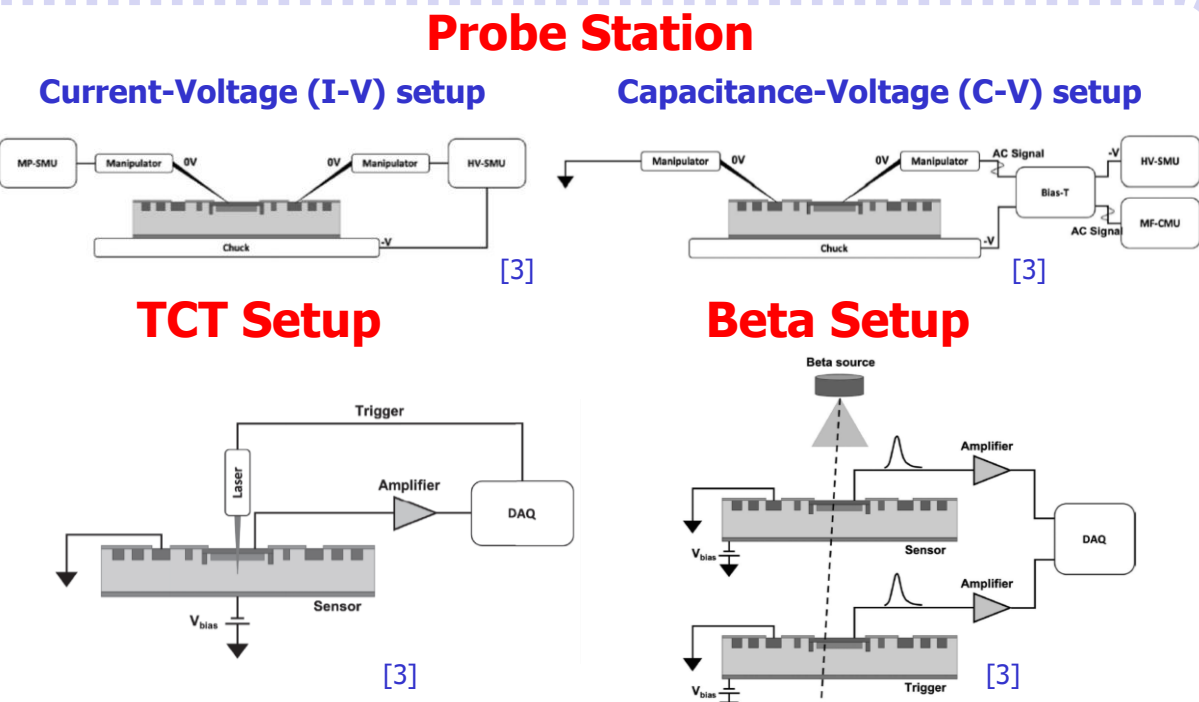


Measurements

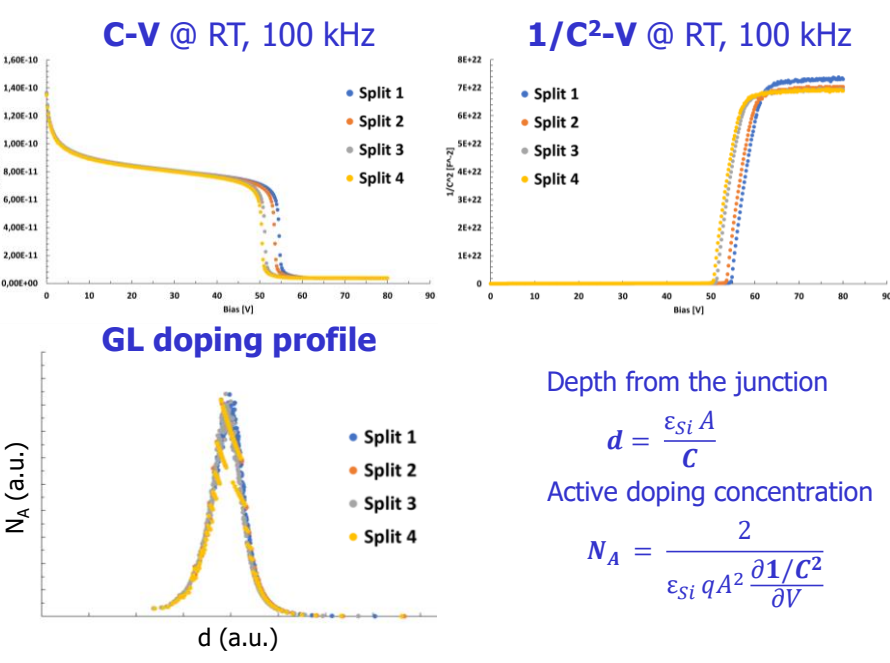
HPK2, Split1 (S1) & Split2 (S2)

Pad size: 1.25 x 1.25 mm²
Edge distance: 300 μm

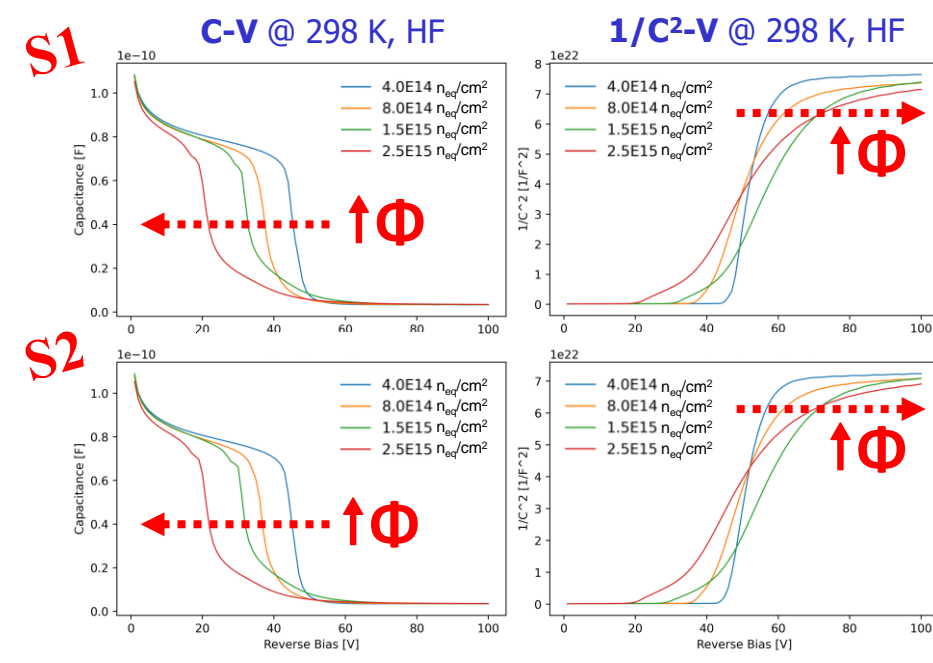
Sample	V _{GL} (V)	V _{BD} (V) @ 20 °C	C _{FD} (pF)
S1	54.5	145	3.6
S2	53.5	168	3.6



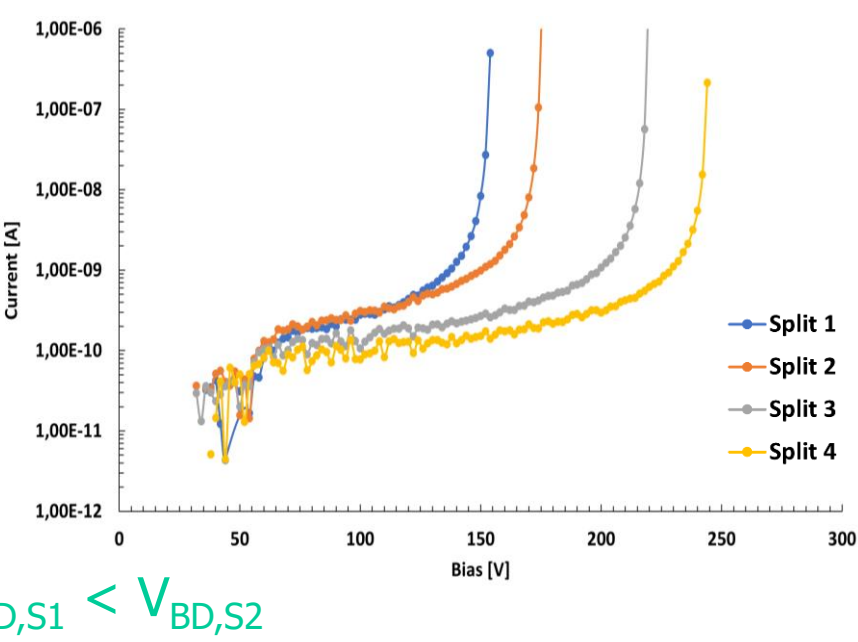
Pre-irradiation



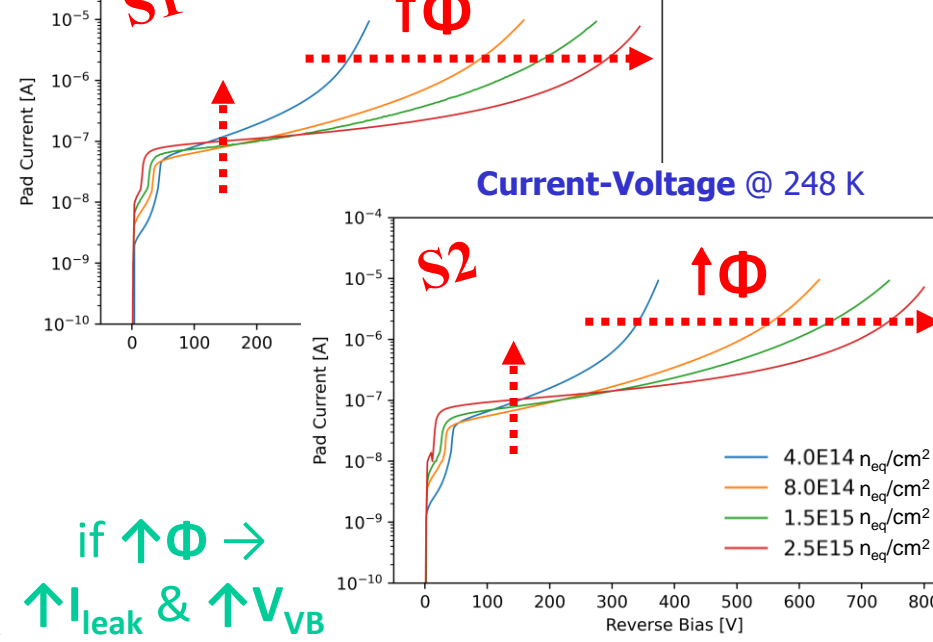
Post-irradiation



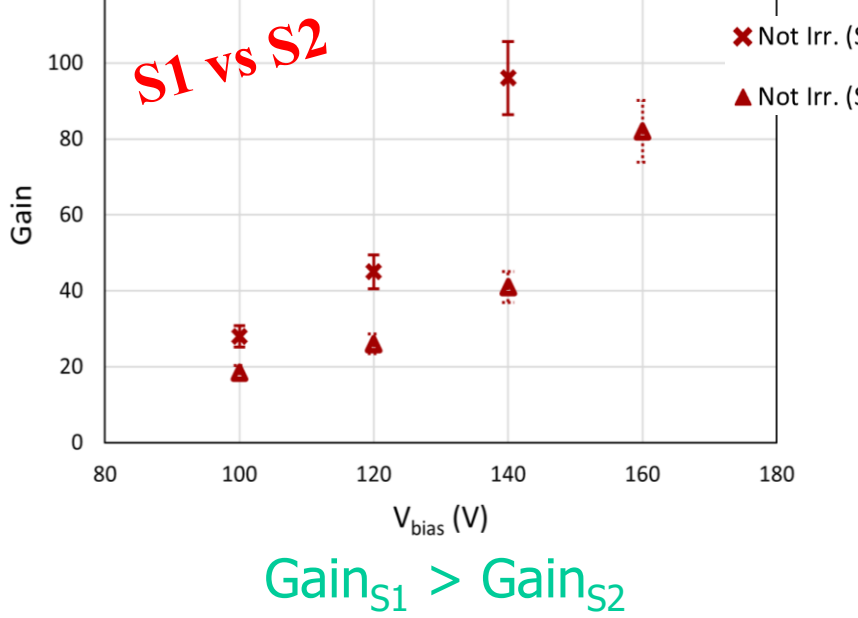
Current-Voltage @ RT



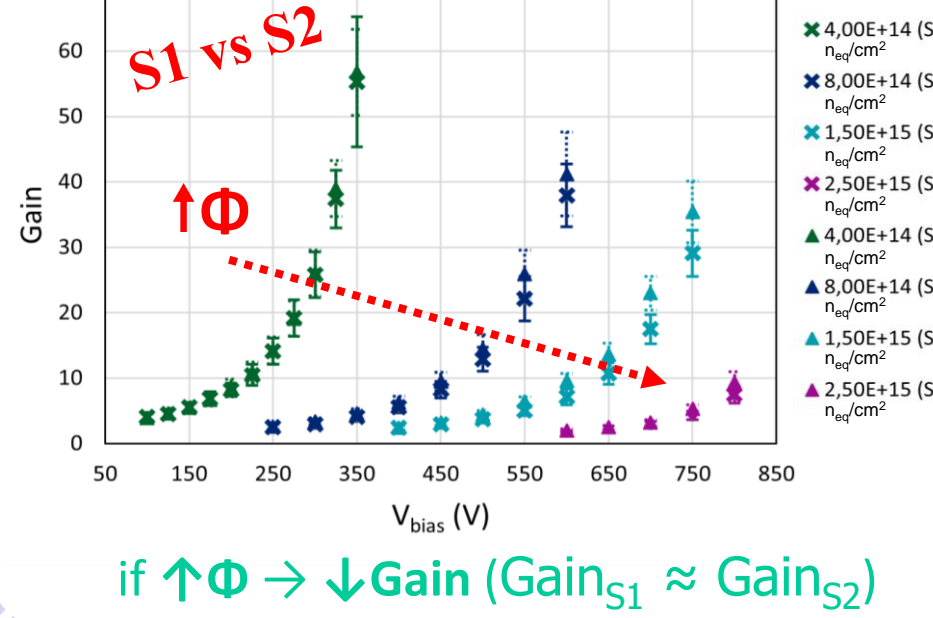
Current-Voltage @ 248 K



Gain-Voltage @ RT, TCT setup



Gain-Voltage @ 248 K, Beta setup

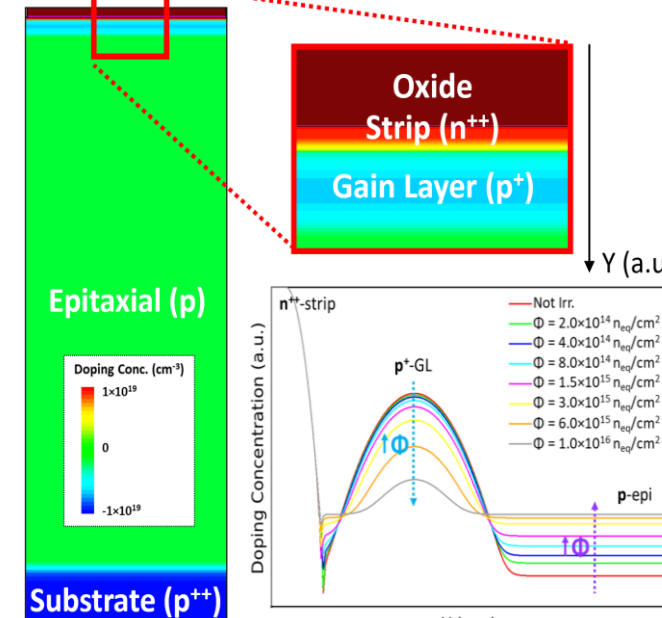


Outcome

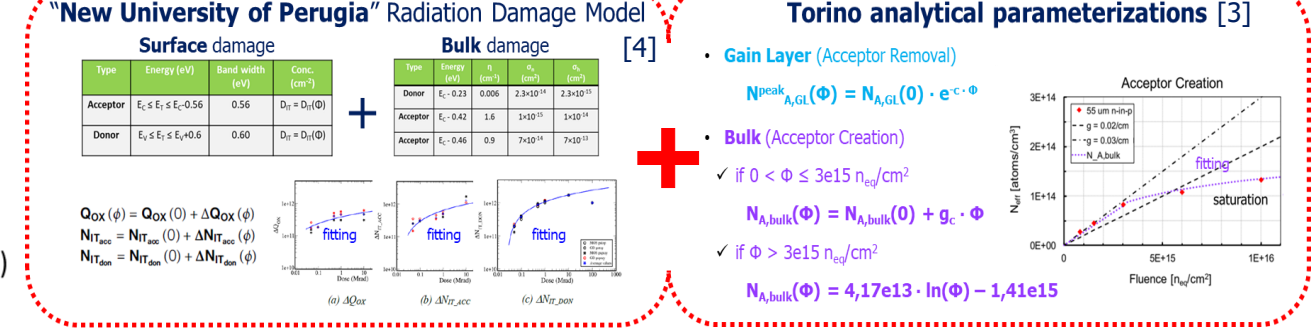
- ✓ Validation of a TCAD model for the numerical simulation of LGAD sensors.
 - ✓ "Perugia Modified Doping" radiation damage model → physics-based approach
 - Traps parametrization ("New University of Perugia" modelling scheme)
 - GL and bulk effective doping evolution with Φ ("Torino analytical parametrizations")
 - ✓ Extensive test campaign on LGAD devices coming from the 2nd production of the Hamamatsu technology (HPK2), both non-irradiated and irradiated ones.
 - ✓ The behaviour of the sensors in terms of I-V and C-V characteristics, as well as their response to different stimulus (laser and beta source) under different operating conditions (i.e., T, f and Φ) have been well reproduced in simulation.
 - ✓ A good agreement has been already achieved with the UFSD2 and UFSD3.2 FBK sensor productions [5].
- General-purpose and high-predictive model within the operating region of the sensor.

Simulations

Layout & Doping Profile

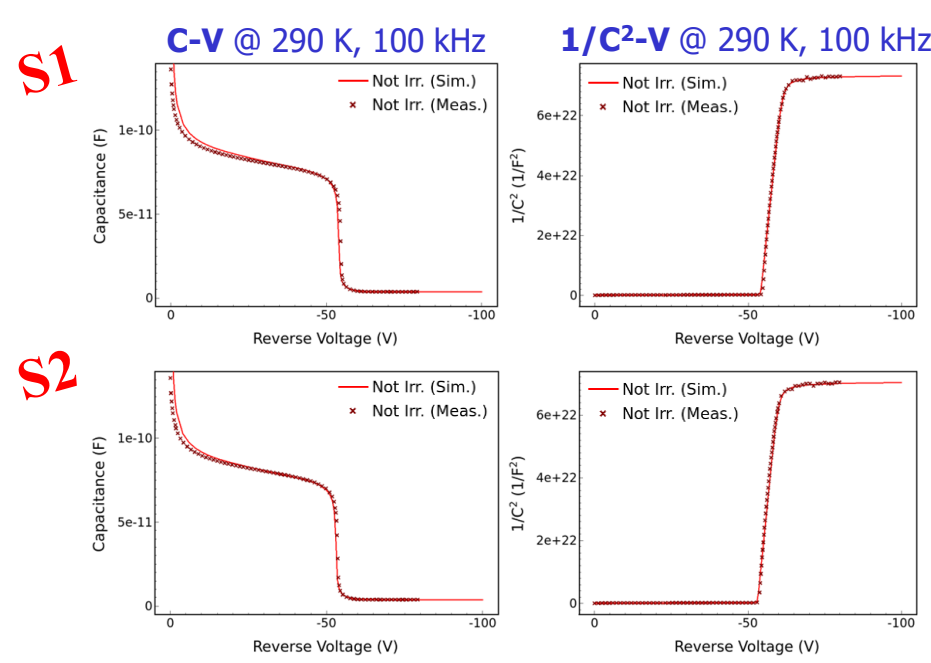


"PerugiaModDoping"

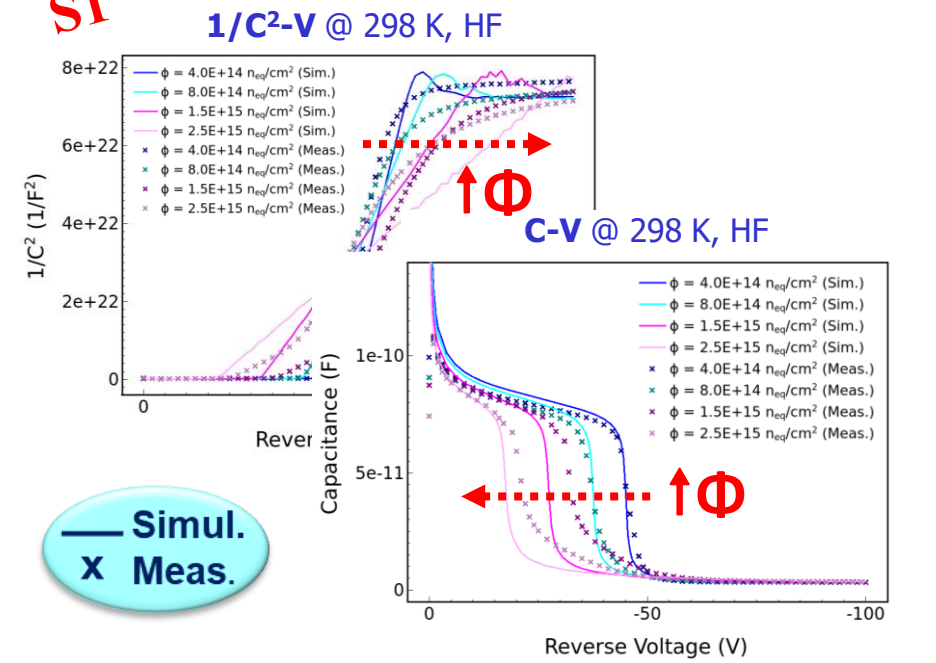


The "Perugia Modified Doping" (PerugiaModDoping) numerical radiation damage model has been already validated by comparing the results of TCAD simulations with experimental data carried out from the measurements of sensors coming from the UFSD2 and UFSD3.2 FBK productions, before and after irradiation [5].

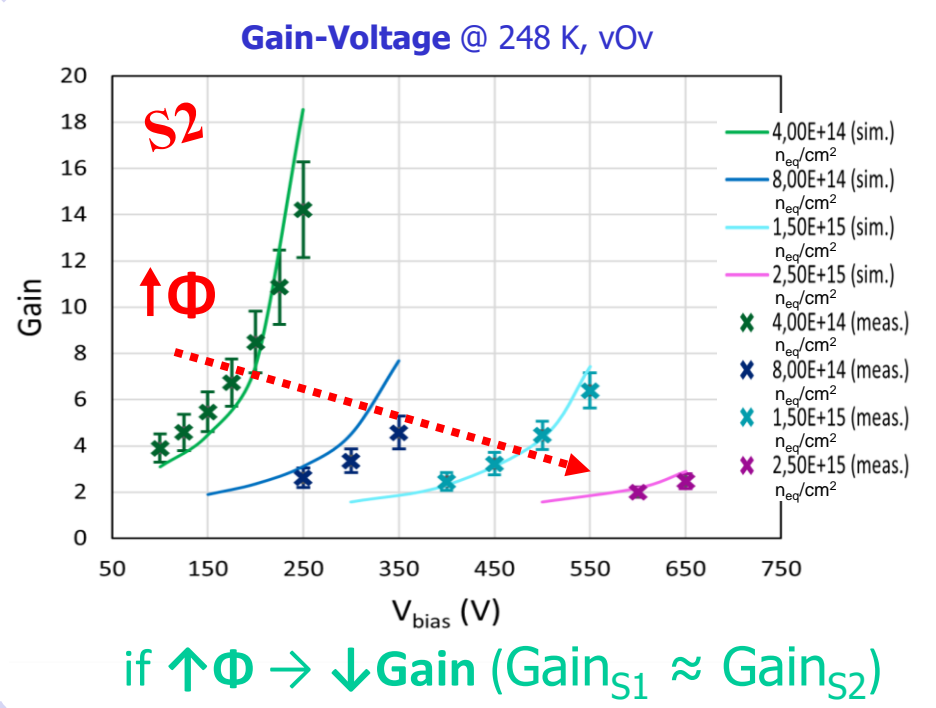
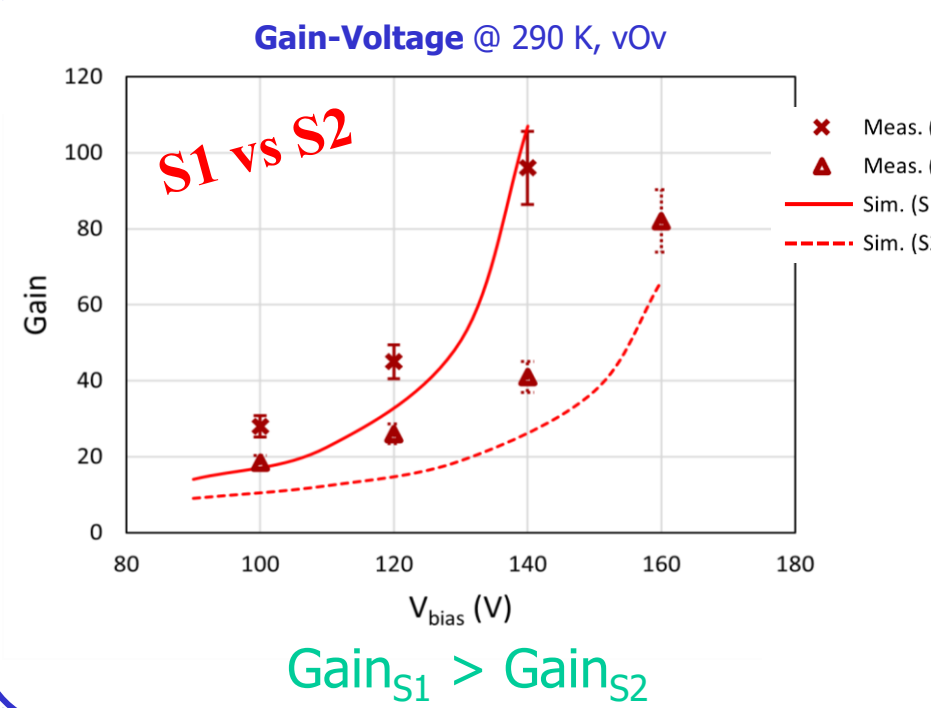
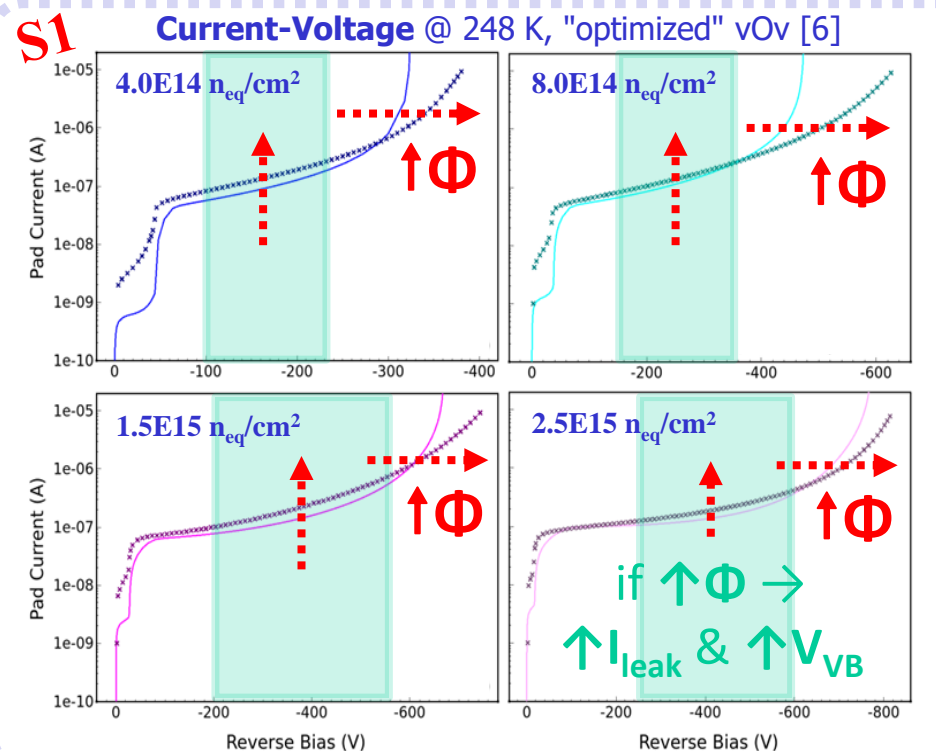
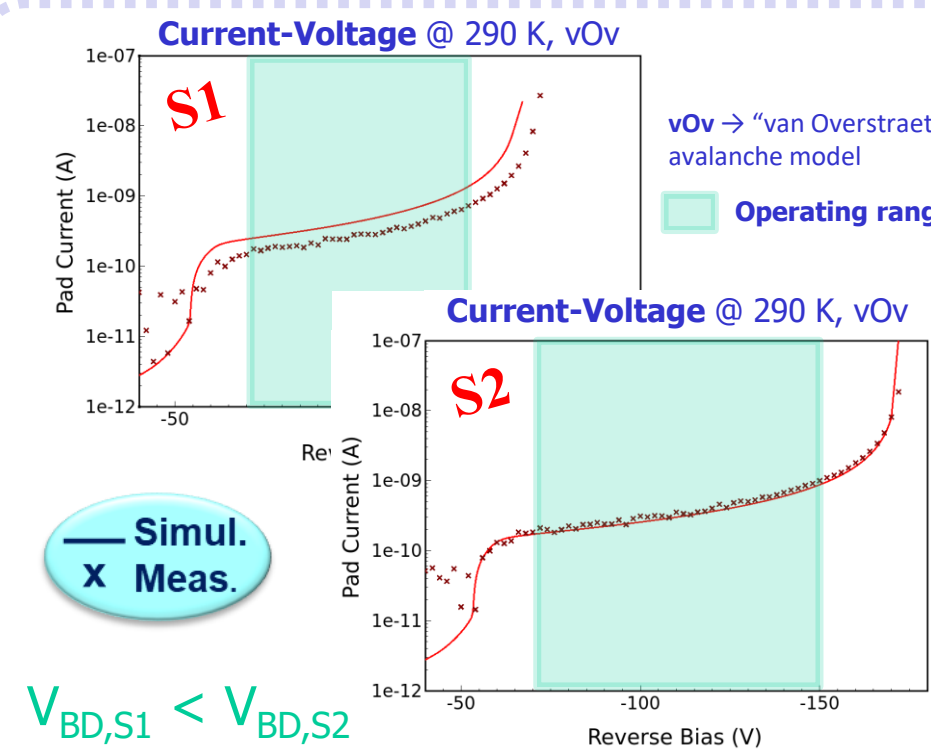
Pre-irradiation



Post-irradiation



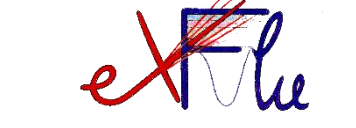
Tuning of the doping profile (C-V matching)



References

- [1] V. Sola *et al.*, "Next-generation tracking system for future hadron colliders", Pos (Vertex2019) 034.
- [2] G. Pellegrini *et al.*, "Technology developments and first measurements of Low Gain Avalanche Detectors (LGAD) for high energy physics applications", NIM, A 765 (2014) 12-16.
- [3] M. Ferrero *et al.*, "An Introduction to Ultra-Fast Silicon Detectors", 1st ed., CRC Press (2021).
- [4] A. Morozzi *et al.*, "TCAD advanced radiation damage modeling in silicon detectors", Pos (Vertex2019) 050.
- [5] P. Asenov *et al.*, "TCAD modeling of bulk radiation damage effects in silicon devices with the Perugia radiation damage model", NIM, A 1040 (2022) 167180.
- [6] E. Curras *et al.*, "Study of Impact Ionization Coefficients in Silicon With Low Gain Avalanche Diodes", IEEE TED, vol. 70, no. 6, pp. 2919-2926 (2023).

Acknowledgement



This project has received funding from the European Union's Horizon 2020 research and innovation programme under GA No. 101004761 and from the Italian MIUR PRIN under GA No. 2017L2XKTJ. The work is performed in collaboration with the INFN CSN5 "eXFlu" research project.

(* tommaso.croci@pg.infn.it)